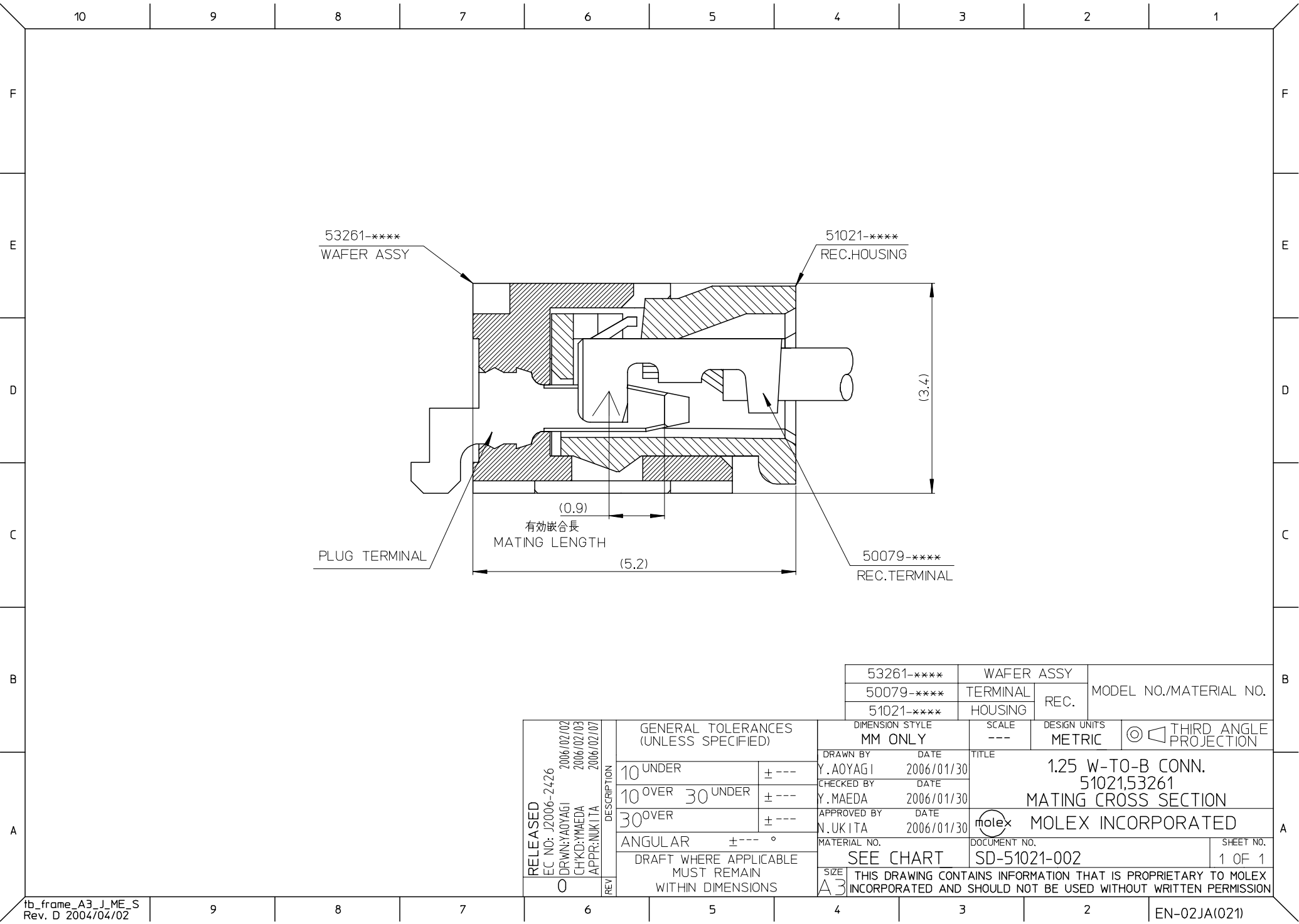
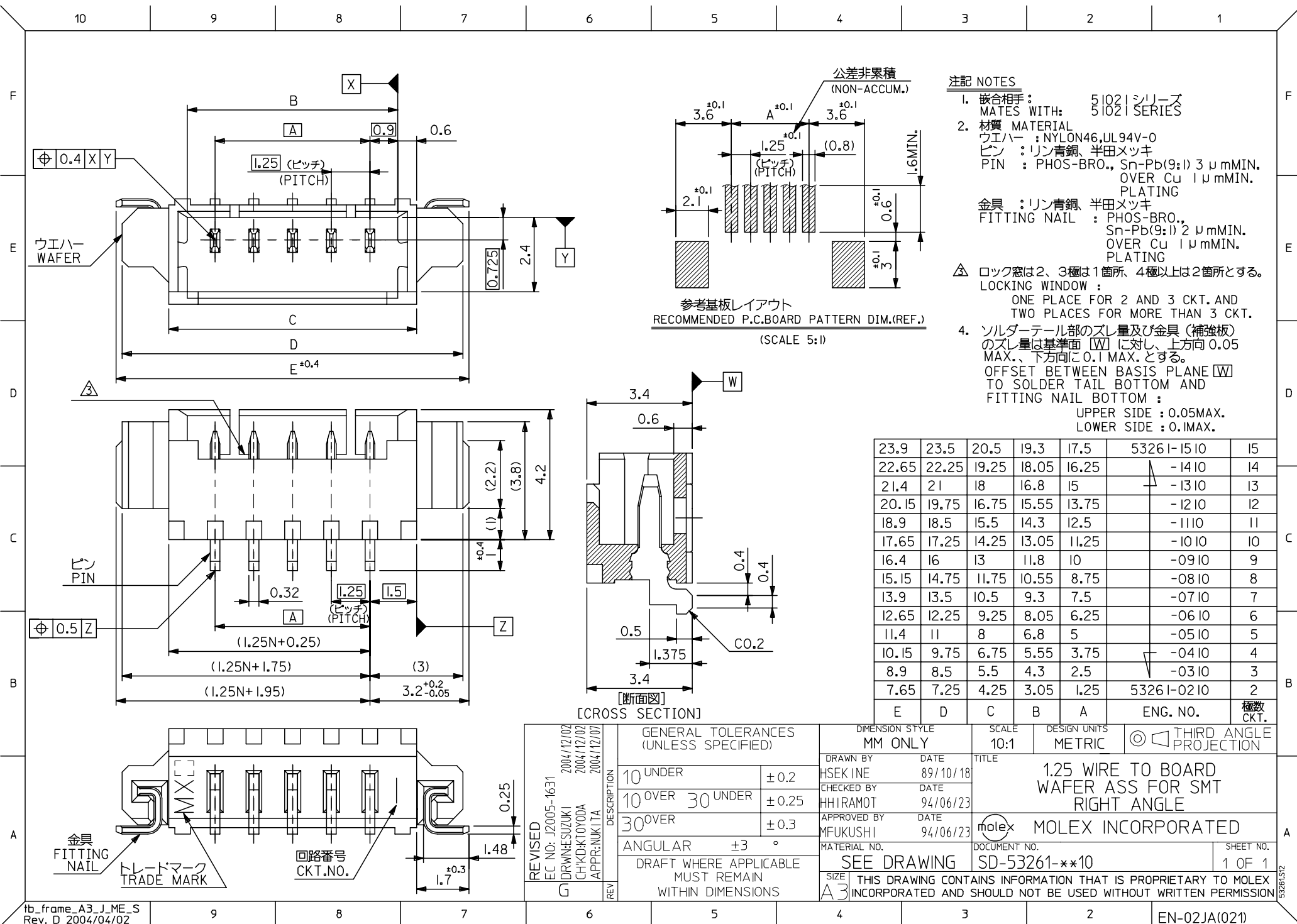
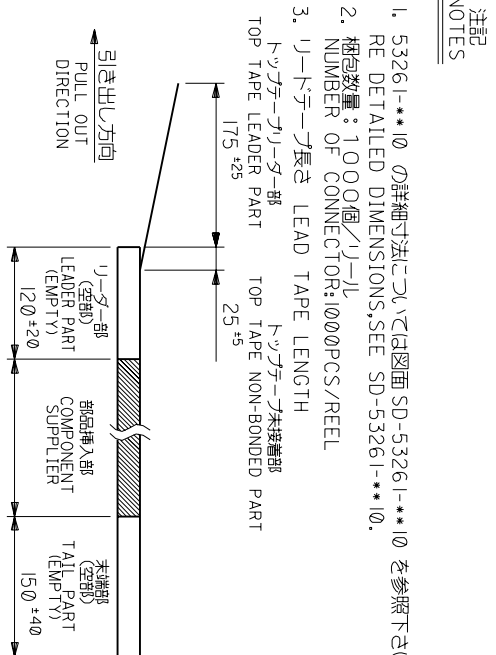
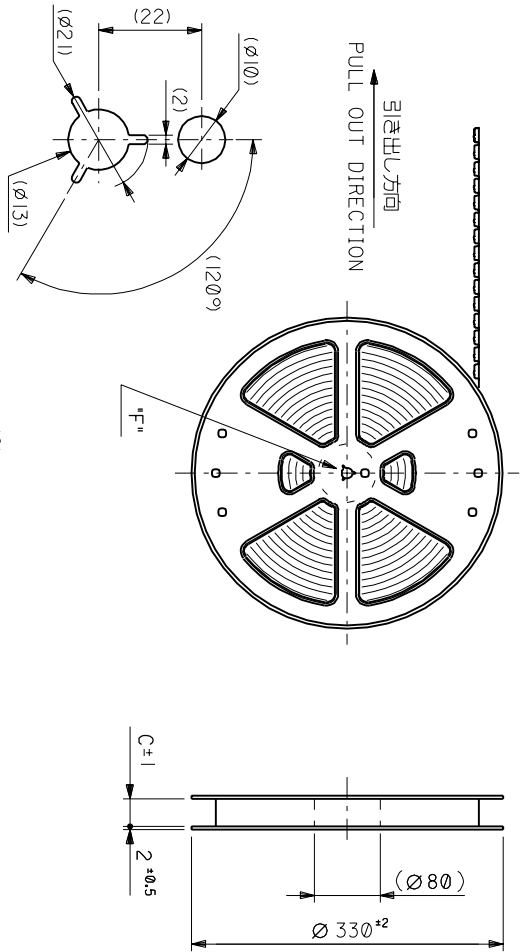




53261-****	WAFER ASSY	MODEL NO./MATERIAL NO.
50079-****	TERMINAL	
51021-****	HOUSING	

RELEASED EC NO: J2006-2426 DRWN:YAOYAGI 2006/02/02 CHKD:YMAEDA 2006/02/03 APPR:NUKITA 2006/02/07 REV 0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± ---	DRAWN BY Y.AOYAGI	DATE 2006/01/30	TITLE 1.25 W-TO-B CONN. 51021,53261 MATING CROSS SECTION				
		10 OVER 30 UNDER	± ---	CHECKED BY Y.MAEDA	DATE 2006/01/30					
		30 OVER	± ---	APPROVED BY N.UKITA	DATE 2006/01/30	MOLEX INCORPORATED				
		ANGULAR ± --- °		MATERIAL NO.			DOCUMENT NO.			SHEET NO.
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART			SD-51021-002			1 OF 1
	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								





4. トッテアの剥離強度: $0.1 \sim 0.59 \text{N}(0.2 \sim 60 \text{gf})$ (剥離方向は下図参照)
PEELING OFF FORCE OF TOP TAPE: $0.1 \sim 0.59 \text{N}(0.2 \sim 60 \text{gf})$
(PEELING DIRECTION IS SHOWN IN FOLLOWING FIG.)

剥離速度: 300mm/min (参考) >
PEELING SPEED: 300mm/min.
(REFERENCE)
引き出し方向
PULL OUT DIRECTION
10°
剥離方向
PEEL OFF DIRECTION

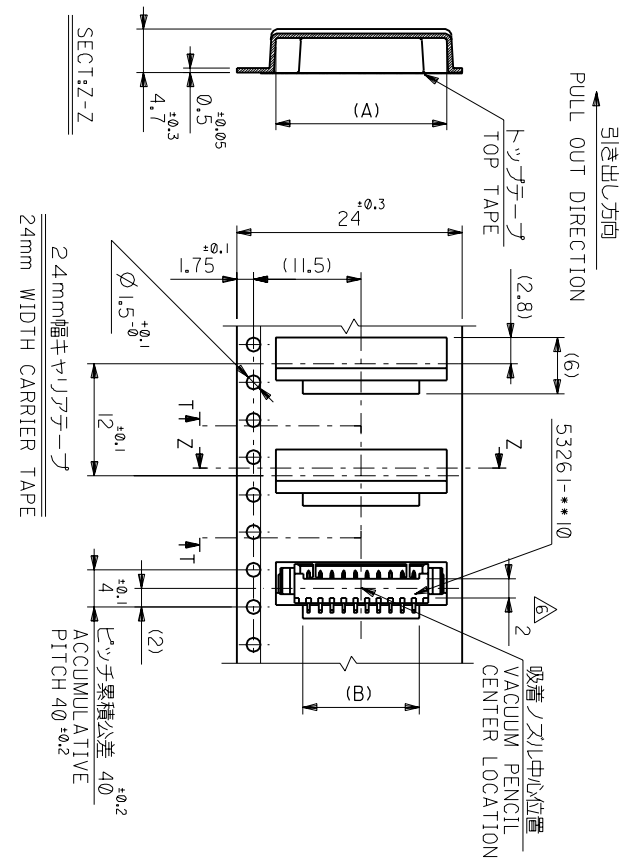
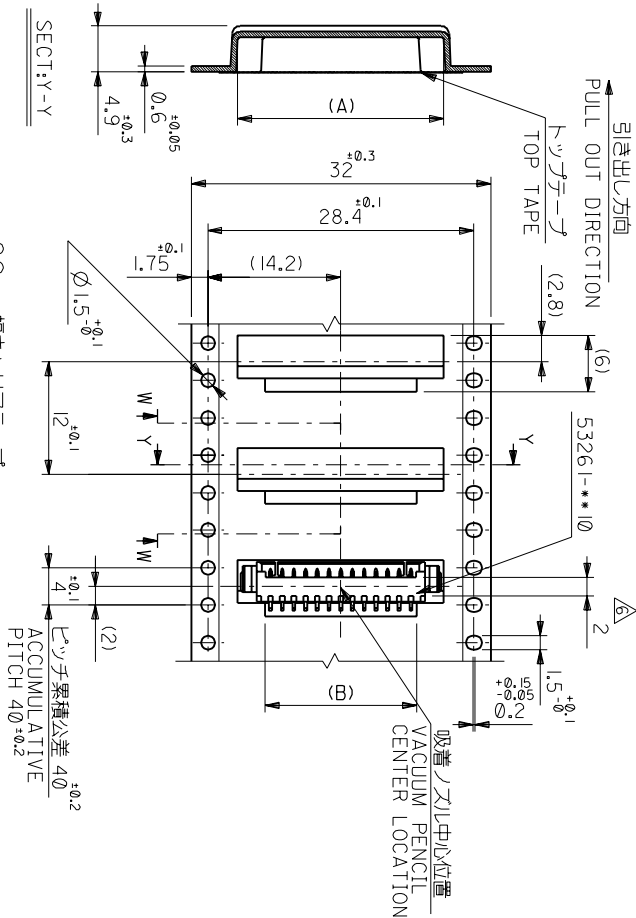
5. 材料 (MATERIAL)
 キヤリヤ-ジ(CARRIER TAPE):ポリプロピレン(POLYPROPYLENE)
 トップテ-プ (TOP TAPE): PET ,PE ,PEF
 リール (REEL):ポリスチレン (PS) <リサイクル材含む>
 POLYSTYREN(PS) <RECYCLE MATERIAL CONTAINED>

△6 コネクタ、ハウジング平面部
CONNECTOR, HOUSING FLAT AREA

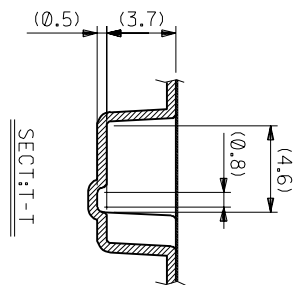
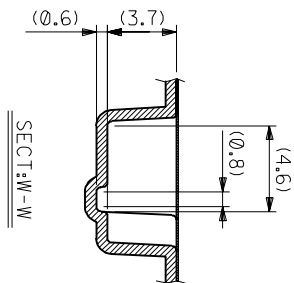
16	16.4	3.7	9.5	53261-0390	3
		2.45	8.25	53261-0290	2
キヤリラーテープ幅 CARRIER TAPE WIDTH	C	B	A	ENG. NO.	極数 C.T.

PE				材料 注記参照 MATERIAL SEE NOTES		MOLEX-JAPAN CO.,LTD. モレックス株式会社	
角度 ANGLE	30°			仕上げ FINISH	—	REVISE ONLY ON CAD SYSTEM	TITLE 名称
30 以下	0.3			適用電線範囲 WIRE RANGE	—	1.25 WIRE TO BOARD CONN.	WAFFER ASS'Y FOR SMT.
10 以下 30 以下	0.25	F	変更 REVISED (J2001-0437)	被覆外径 INS. RANGE	—	EMBOSSD TAPE PACKAGE	
10 未満	0.2	E	変更 REVISED (J2001-036522)	S.M. K.T. H.J. (93/6/1)	DR.WIN BY 93/6/1 K.T.O.UO I.YAMAGUCHI	DWG. NO.	SHEET 1 OF 3
一般公差			変更内 REVISION RECORD	DR. CHK.	DATE M.FUKUSHIMA	REV	REV
					尺度 SCALE	—	SD-53261-**90
							F

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 EN-0(C)(32)MXJ-32



32mm幅キヤリテーブ
32mm WIDTH CARRIER TAPE

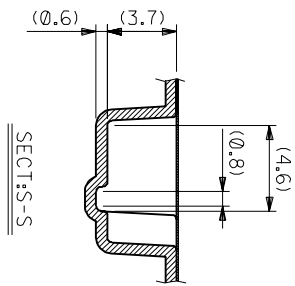


角度	ANGLE	±3°
30 以上	±0.3	
10 以上 30 未満	±0.2	
10 未満	±0.2	
一般公差		
GENERAL TOLERANCES		

材料 MATERIAL		注記参照 SEE NOTES		 MOLEX - JAPAN CO.,LTD. 日本モリックス株式会社	
仕上げ FINISH		—		REVISE ONLY ON CAD SYSTEM	
適用電線範囲 WIRE RANGE		—		TITLE 名称 1.25 WIRE TO BOARD CONN. WAFER ASSY FOR SMT. EMBOSSED TAPE PACKAGE	
挿通外径 INS. RANGE		—		DWG. NO. SHEET 2 OF 3 REV SD-53261-90 F	
5	REVISED (改訂) 改訂後 K.I.J. 93/6/1	S.M. 日付 93/6/1	DRAWN BY 93/6/1 K.T.OJIO	CHK.D BY 93/6/2 T.YAAGAGUCHI	
F	改訂 改訂後 K.I.J. 93/6/1	S.M. 日付 93/6/1	DRAWN BY 93/6/1 K.T.OJIO	CHK.D BY 93/6/2 T.YAAGAGUCHI	
E	変更及改訂 改訂後 K.I.J. 93/6/1	S.M. 日付 93/6/1	DRAWN BY 93/6/1 K.T.OJIO	CHK.D BY 93/6/2 T.YAAGAGUCHI	
リ	変更 改訂後 K.I.J. 93/6/1	S.M. 日付 93/6/1	DRAWN BY 93/6/1 K.T.OJIO	CHK.D BY 93/6/2 T.YAAGAGUCHI	

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TEN PERMISSION
EN-01C(032)MXJ-32



SECT: S-S

44	44.4	18.7	24.5	5326-1590	15
	C	B	A	ENG. NO.	種数 Ckt.
キャリアテープ幅 CARRIER TAPE WIDTH					

 MOLEX-JAPAN CO.,LTD. 日本モリス株式会社						注記参照 SEE NOTES					
MATERIAL						仕上げ					
						FINISH ————					
						適用電線範囲 ————					
						WIRE RANGE					
						被覆外径 INS. RANGE ————					
						DRAIN BY 353/6/1 CHK'D BY '00/12/8					
						AP'D BY '00/12/8 T.YAAGUCHI					
						MAFUKUSHIMA SCALE ————					
REVISE ONLY ON CAD SYSTEM TITLE 名称 1.25 WIRE TO BOARD CONN WAFER ASS'y FOR SMT. EMBOSSED TAPE PACKAGE DWG. NO. SHEET 3 OF 3 REVISION SD-53261-**90 F											

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